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LGA



✓ Active

TE CONNECTIVITY (TE)

RIGHT SIDE LGA3647-0 SOCKET-P0 FOR ODM

LGA Sockets

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LGH

2-2129710-6

TE Internal Number: 2-2129710-6

EU RoHS Compliant EU ELV Compliant

Socket Type LGA 3647

Number of Positions 1823

Contact Mating Area Plating Material Gold Contact Mating Area Plating Thickness 30

PCB Mounting Style Surface Mount - Solder Ball

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PRODUCT DRAWING

English



3D PDF

DOCUMENTATION

Product Drawings

LGA 3647-X SOCKET ASSY For INDIVIDUAL PART PACKAGE

PDF

English

CAD Files

3D PDF

PDF

3D

Customer View Model

2D_DXF.ZIP

English

Customer View Model

3D_IGS.ZIP

English

Customer View Model

3D_STP.ZIP

English

Product Specifications

Application Specification

Application Specification For LGA3647 Socket

PDF

English

Product Environmental Compliance

TE Material Declaration

MD_2-2129710-6_0228201761_dmtec

PDF

English

Agency Approvals

UL Report

LGA Series

PDF

English

FEATURES

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Please review product documents or contact us for the latest agency approval information.

Please Note: Use the Product Drawing for all design activity.

Product Type Features

Product Type Socket

Configuration Features

Number of Positions 1823

Grid Spacing $.9906 \times .8585 \, \text{mm} [.039 \times .0338 \, \text{in}]$

Body Features

Plating Thickness (µin) 30 Plating Material Gold Frame Style C Shape

Contact Features

Socket Type LGA 3647

Contact Mating Area Plating Material Gold Contact Mating Area Plating Thickness 30 Contact Base Material Copper Alloy

Mechanical Attachment

PCB Mounting Style Surface Mount - Solder Ball

Heat Sink Attachment Without

Housing Features

Housing Color Black

Housing Material High Temperature Thermoplastic

Industry Standards

UL Flammability Rating UL 94V-0

Packaging Features

Packaging Method Tray

Tray Color Blue

Other

Comment Lead-Free Solderball

Statement of Compliance

Statement of Compliance

PDF